

SCT3040KW7 N-channel SiC power MOSFET

V _{DSS}	1200V
R _{DS(on)} (Typ.)	40mΩ
Ι _D ^{*1}	56A
P _D	267W

Features

- 1) Low on-resistance
- 2) Fast switching speed
- 3) Fast reverse recovery
- 4) Easy to parallel
- 5) Simple to drive
- 6) Pb-free lead plating ; RoHS compliant

Application

- Solar inverters
- DC/DC converters
- · Switch mode power supplies
- Induction heating
- Motor drives

• Absolute maximum ratings $(T_a = 25^{\circ}C)$

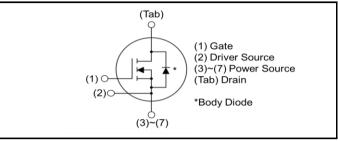
Parameter		Symbol	Value	Unit
Drain - Source Voltage		V _{DSS}	1200	V
$T_c = 25^{\circ}C$		Ι _D *1	56	A
Continuous Drain current	$T_c = 100^{\circ}C$	ا _D *1	39	А
Pulsed Drain current		I _{D,pulse} *2	140	A
Gate - Source voltage (DC)		V _{GSS}	-4 to +22	V
Gate - Source surge voltage (t _{surge} < 300ns)		V _{GSS_surge} *3	-4 to +26	V
Recommended drive voltage		V _{GS_op} *4	0 / +18	V
Junction temperature		T _j	175	°C
Range of storage temperature		T _{stg}	-55 to +175	°C

●Outline

TO-263-7L



Inner circuit



Please note Driver Source and Power Source are not exchangeable. Their exchange might lead to malfunction.

Packaging specifications

	Packing	Embossed tape
	Reel size (mm)	330
Tuno	Tape width (mm)	24
Туре	Basic ordering unit (pcs)	1000
	Taping code	TL
	Marking	SCT3040KW7

•Electrical characteristics ($T_a = 25^{\circ}C$)

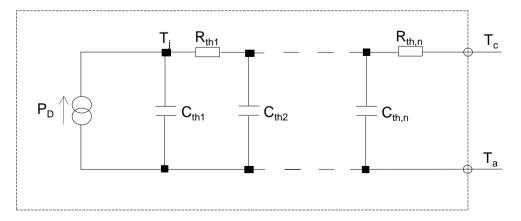
Parameter	Symbol	Conditions		Unit		
Faidilielei	Symbol Conditions		Min.	Тур.	Max.	Offic
		$V_{GS} = 0V, I_D = 1mA$				
Drain - Source breakdown voltage	V _{(BR)DSS}	T _j = 25°C	1200	-	-	V
		T _j = -55°C	1200	-	-	
		$V_{GS} = 0V, V_{DS} = 1200V$				
Zero Gate voltage Drain current	I _{DSS}	T _j = 25°C	-	1	10	μA
		T _j = 150°C	-	2	-	
Gate - Source leakage current	I _{GSS+}	$V_{GS} = +22V, V_{DS} = 0V$	-	-	100	nA
Gate - Source leakage current	I _{GSS-}	$V_{GS} = -4V$, $V_{DS} = 0V$	-	-	-100	nA
Gate threshold voltage	V _{GS (th)}	$V_{DS} = 10V, I_{D} = 10mA$	2.7	-	5.6	V
		$V_{GS} = 18V, I_{D} = 20A$				
Static Drain - Source on - state resistance	R _{DS(on)} *5	$T_j = 25^{\circ}C$	-	40	52	mΩ
		T _j = 150°C	-	68	-	
Gate input resistance	R_{G}	f = 1MHz, open drain	-	7	-	Ω

Thermal resistance

Parameter	Symbol	Values			Unit
Falameter	Symbol	Min.	Тур.	Max.	Onit
Thermal resistance, junction - case	R _{thJC}	-	0.44	0.56	°C/W

•Typical Transient Thermal Characteristics

Symbol	Value	Unit	Symbol	Value	Unit
R _{th1}	5.89×10 ⁻²		C _{th1}	2.17×10 ⁻³	
R _{th2}	1.79×10 ⁻¹	K/W	C _{th2}	1.31×10 ⁻²	Ws/K
R _{th3}	1.61×10 ⁻¹		C _{th3}	1.12×10 ⁻²	





●Electrical characteristics (T_a = 25°C)

Deremeter	Symbol	Conditions	Values			Linit
Parameter	Symbol	Symbol Conditions		Тур.	Max.	Unit
Transconductance	𝔤 _{fs} ^{∗5}	$V_{DS} = 10V, I_{D} = 20A$	-	8.3	-	S
Input capacitance	C _{iss}	$V_{GS} = 0V$	-	1337	-	
Output capacitance	C _{oss}	V _{DS} = 800V	-	76	-	pF
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	27	-	
Effective output capacitance, energy related	C _{o(er)}	$V_{GS} = 0V$ $V_{DS} = 0V$ to 600V	-	122	-	pF
Total Gate charge	Q_g^{*5}	$V_{DS} = 600V$ $I_{D} = 20A$	-	107	-	
Gate - Source charge	Q _{gs} ^{*5}	$V_{GS} = 18V$	-	17	-	nC
Gate - Drain charge	Q_{gd} *5	See Fig. 1-1.	-	56	-	
Turn - on delay time	t _{d(on)} *5	$V_{DS} = 600V$ $I_{D} = 20A$	-	6	-	
Rise time	t _r *5	V _{GS} = 0V/+18V	-	19	-	20
Turn - off delay time	t _{d(off)} *5	$R_{G} = 0\Omega, L = 750 \mu H$ L _σ = 50nH, C _σ = 10pF	-	29	-	ns
Fall time	t _f *5	See Fig. 2-1, 2-2, 2-3.	-	19	-	-
Turn - on switching loss	E _{on} *5	E _{on} includes diode reverse recovery.	-	286	-	
Turn - off switching loss	${\sf E}_{\sf off}$ *5		-	69	-	μJ



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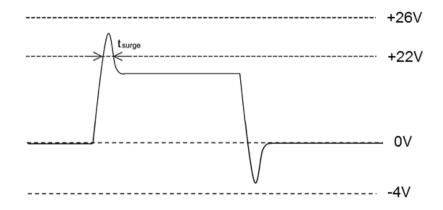
•Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Deremeter	Symbol Conditions	Values			L locit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Body diode continuous, forward current	ا _S *1	T _c = 25°C	-	-	56	А
Body diode direct current, pulsed	I _{SM} *2	T _c = 25 C	-	-	140	А
Forward voltage	V_{SD} *5	$V_{GS} = 0V, I_D = 20A$	-	3.2	-	V
Reverse recovery time	t _{rr} *5	$I_F = 20A$ $V_R = 600V$	-	25	-	ns
Reverse recovery charge	Q _{rr} *5	di/dt = 2500A/µs	-	535	-	nC
Peak reverse recovery current	^{*5}	$L_{\sigma} = 50$ nH, $C_{\sigma} = 10$ pF See Fig. 3-1, 3-2.	-	35	-	A

*1 Limited by maximum temperature allowed.

*2 $P_W \leq$ 10µs, Duty cycle \leq 1%

*3 Example of acceptable V_{GS} waveform



Please note especially when using driver source that V_{GSS_surge} must be in the range of absolute maximum rating.

*4 Please be advised not to use SiC-MOSFETs with V_{GS} below 13V as doing so may cause thermal runaway.

*5 Pulsed



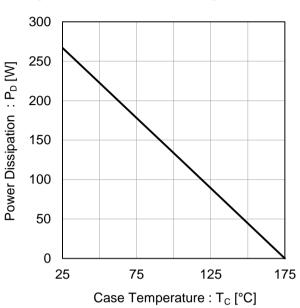
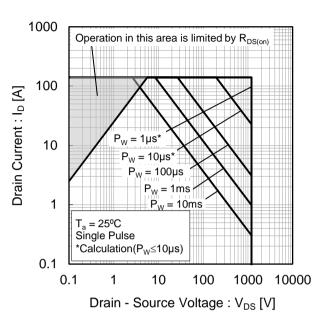
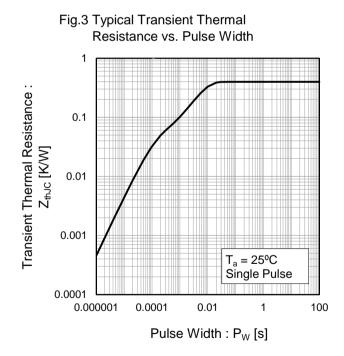


Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area





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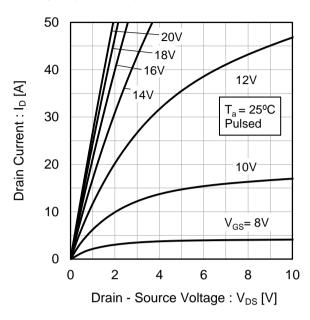


Fig.4 Typical Output Characteristics(I)

Fig.5 Typical Output Characteristics(II)

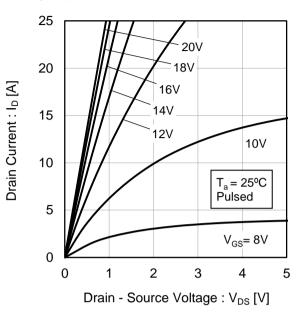
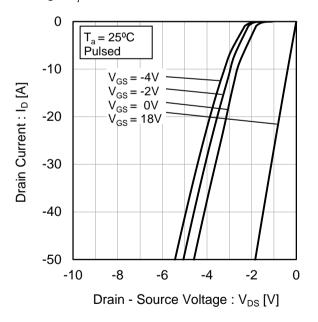
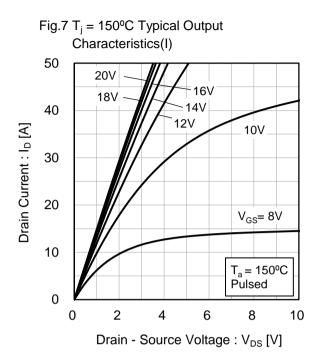


Fig.6 T_i = 25°C 3rd Quadrant Characteristics









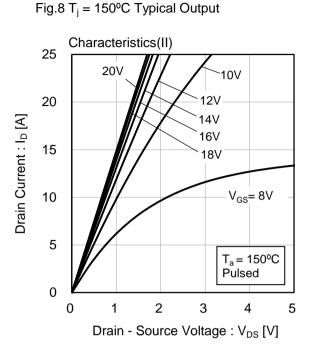
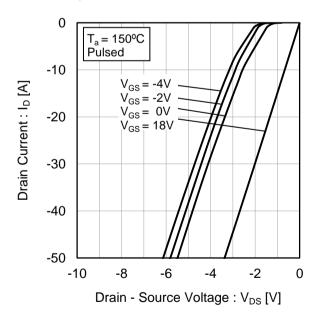
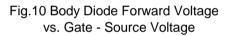
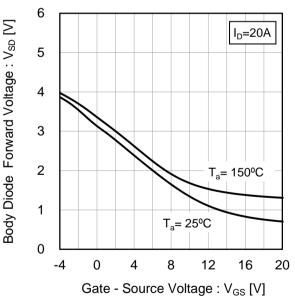


Fig.9 $T_i = 150^{\circ}C$ 3rd Quadrant Characteristics









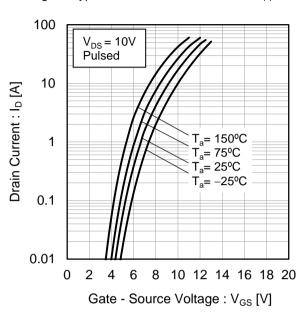
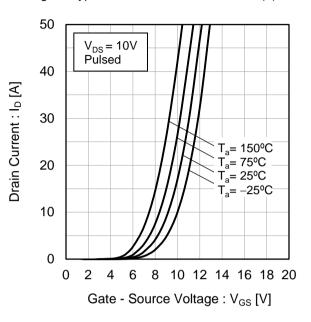


Fig.11 Typical Transfer Characteristics (I)

Fig.12 Typical Transfer Characteristics (II)



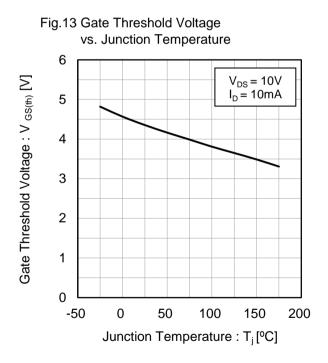
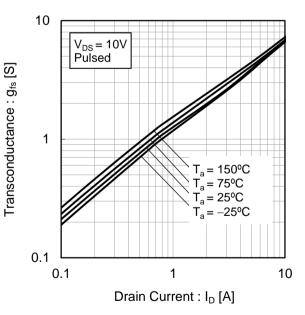


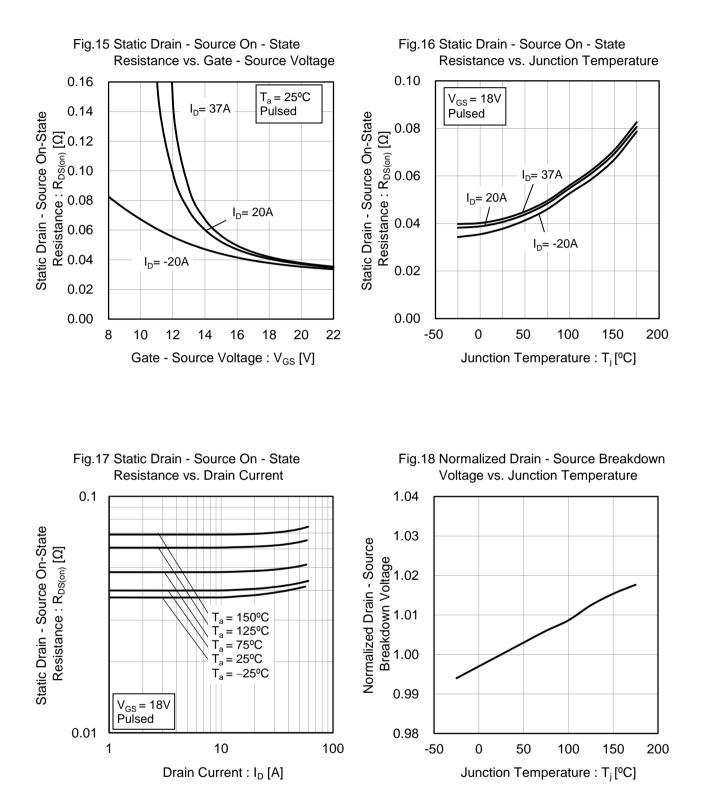
Fig.14 Transconductance vs. Drain Current

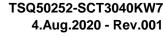


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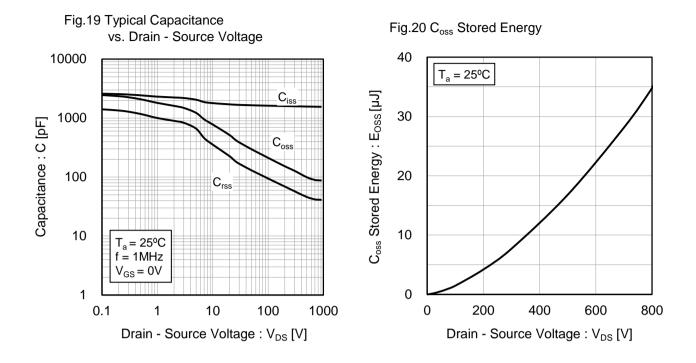
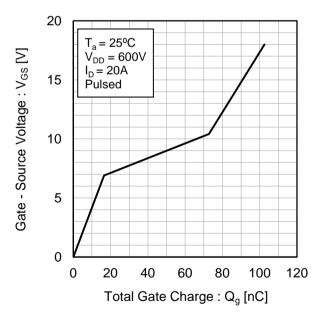
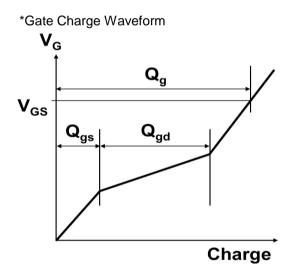
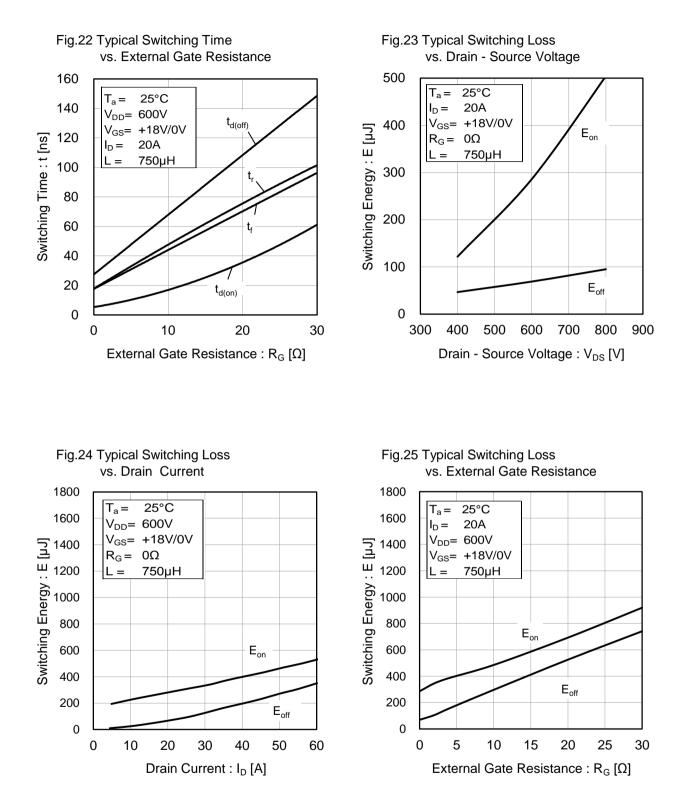


Fig.21 Dynamic Input Characteristics













Measurement circuits and waveforms

Fig.1-1 Gate Charge Measurement Circuit

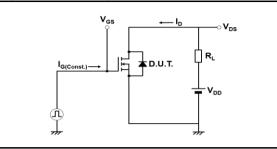


Fig.2-1 Switching Characteristics Measurement Circuit

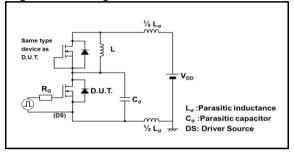


Fig.2-3 Waveforms for Switching Energy Loss

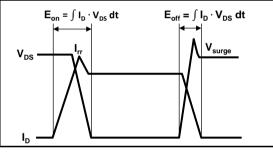


Fig.3-1 Reverse Recovery Time Measurement Circuit

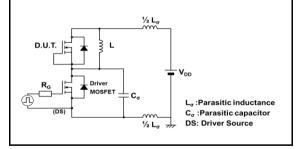


Fig.2-2 Waveforms for Switching Time

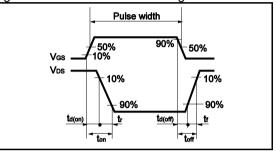
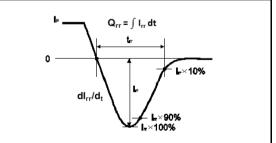


Fig.3-2 Reverse Recovery Waveform







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